PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Gerald Krimmer	12/05/2011

RECEIVING PARTY DATA

Name:	Atmel Corporation	
Street Address:	2325 Orchard Parkway	
City:	San Jose	
State/Country:	CALIFORNIA	
Postal Code:	95131	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13312636

CORRESPONDENCE DATA

Fax Number: (214)661-4559 **Phone**: 2149536500

Email: PTOmail1@bakerbotts.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: Baker Botts L.L.P.

Address Line 1: 2001 Ross Avenue, 6th Floor

Address Line 4: Dallas, TEXAS 75201

ATTORNEY DOCKET NUMBER: 080900.0609

NAME OF SUBMITTER: Paula Hurley

Total Attachments: 2

source=Assignment_080900_0609#page1.tif source=Assignment_080900_0609#page2.tif

CH \$40 00

PATENT REEL: 027344 FRAME: 0418 ATTORNEY DOCKET 080900.0609 P000449/US/2 ASSIGNMENT

1 of 2

ASSIGNMENT

WHEREAS, I, the undersigned sole inventor or one of the undersigned joint inventors, of residence as listed, have invented new and useful subject matter disclosed by the patent application entitled *Semiconductor Package*;

WHEREAS, Atmel Corporation, ("Assignee") a Delaware Corporation, with an address of 2325 Orchard Parkway, San Jose, California 95131, wants to acquire my entire right, title, and interest in and to said subject matter and in and to said patent application and any and all letters patent that issue therefrom;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which I hereby acknowledge, I assign to Assignee all right, title, and interest in and to said subject matter and in and to said application and any and all patents that issue therefrom, as well as any and all divisions, reissues, continuations, continuations in part, and extensions thereof. I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said subject matter, insofar as my interest is concerned, to Assignee.

I hereby assign to Assignee all right, title, and interest in and to said subject matter throughout the world, including the right to file applications and obtain patents, utility models, industrial models, and designs for said subject matter in Assignee's own name throughout the world and further including the right to claim priority to said patent application under any international convention, all rights to publish cautionary notices reserving ownership of said subject matter, and all rights to register said subject matter in appropriate registries throughout the world. I shall execute any and all powers of attorney, applications, assignments, declarations, affidavits, and any and all other papers in connection therewith to perfect Assignee's right, title, and interest in and to said subject matter throughout the world.

I hereby covenant and agree that I have full right to convey the entire interest herein assigned and that I have not executed, and shall not execute, any agreement in conflict herewith.

I shall communicate to Assignee any and all facts known to me concerning any improvements. At the expense of Assignee, I shall testify in any and all legal proceedings, sign any and all lawful papers, execute any and all divisional, continuation, continuation-in-part, reissue, and substitute applications, make any and all lawful oaths or declarations, and generally do everything possible to perfect Assignee's right, title, and interest in and to said subject matter and to help Assignee obtain and enforce proper protection for said subject matter in any and all countries.

This Assignment shall bind the parties' successors, assigns, and legal representatives.

PAL01:113538.1

PATENT REEL: 027344 FRAME: 0419 ATTORNEY DOCKET 080900.0609 P000449/US/2 **ASSIGNMENT**

2 of 2

Title of Patent Application: Semigonductor Package

Signature of Inventor:

Name of Inventor: Gerald KRIMMER

Residence: Heilbronn, Germany

Date: 25. 12. 2011

PAL01:113538.1

RECORDED: 12/06/2011

PATENT REEL: 027344 FRAME: 0420